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 Package Options Include Plastic Small-Outline (D) Packages, Ceramic Chip Carriers (FK), and Standard Plastic (N) and Ceramic (J) 300-mil DIPs

TYPE	TYPICAL MAXIMUM CLOCK FREQUENCY (MHz)	TYPICAL POWER DISSIPATION PER FLIP-FLOP (mW)
'ALS109A	50	6
'AS109A	129	29

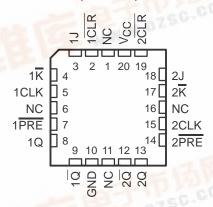
description

These devices contain two independent J-K positive-edge-triggered flip-flops. A low level at the preset (PRE) or clear (CLR) inputs sets or resets the outputs regardless of the levels of the other inputs. When PRE and CLR are inactive (high), data at the J and \overline{K} inputs meeting the setup-time requirements are transferred to the outputs on the positive-going edge of the clock (CLK) pulse. Clock triggering occurs at a voltage level and is not directly related to the rise time of the clock pulse. Following the hold-time interval, data at the J and \overline{K} inputs can be changed without affecting the levels at the outputs. These versatile flip-flops can perform as toggle flip-flops by grounding \overline{K} and tying J high. They also can perform as D-type flip-flops if J and \overline{K} are tied together.

SN54ALS109A, SN54AS109A . . . J PACKAGE SN74ALS109A, SN74AS109A . . . D OR N PACKAGE (TOP VIEW)



SN54ALS109A, SN54AS109A . . . FK PACKAGE (TOP VIEW)



NC - No internal connection

The SN54ALS109A and SN54AS109A are characterized for operation over the full military temperature range of -55°C to 125°C. The SN74ALS109A and SN74AS109A are characterized for operation from 0°C to 70°C.

FUNCTION TABLE

		INPUTS			OUTI	PUTS
PRE	CLR	CLK	J	K	Q	Q
L	Н	Х	Χ	Х	Н	L
Н	L	X	Χ	X	L	Н
L	L	X	Χ	X	H [†]	H [†]
Н	Н	\uparrow	L	L	L	Н
Н	Н	\uparrow	Н	(L	Tog	gle
Н	Н	1	L	Н	Q0	Q ₀
Н	CHG	\uparrow	Н	Н	Н	L
Н	Н	L	Χ	X	Q0	Q0

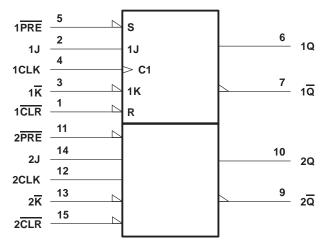
The output levels in this configuration are not specified to meet the minimum levels for V_{OH} if the lows at PRE and CLR are near V_{IL} maximum. Furthermore, this configuration is nonstable; that is, it does not persist when either PRE or CLR returns to its inactive (high) level.





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logic symbol†



[†] This symbol is in accordance with ANSI/IEEE Std 91-1984 and IEC Publication 617-12. Pin numbers shown are for the D, J, and N packages.

absolute maximum ratings over operating free-air temperature range (unless otherwise noted)‡

Supply voltage, V _{CC}	7 V
Input voltage, V _I	7 V
Operating free-air temperature range, T _A : SN54ALS109A	
SN74ALS109A	0°C to 70°C
Storage temperature range	-65°C to 150°C

[‡] Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

recommended operating conditions

			SN	54ALS10	9A	SN7	4ALS10	9A	UNIT
			MIN	NOM	MAX	MIN	NOM	MAX	UNIT
Vcc	Supply voltage		4.5	5	5.5	4.5	5	5.5	V
VIH	High-level input voltage		2			2			V
V _{IL}	Low-level input voltage				0.7			0.8	V
IOH	High-level output current				-0.4			-0.4	mA
lOL	Low-level output current				4			8	mA
fclock	Clock frequency		0		30	0		34	MHz
		PRE or CLR low	15			15			
t _W	Pulse duration	CLK high	16.5			14.5			ns
		CLK low	16.5			14.5			
	Outure the electron OLIC	Data	15			15			ns
t _{su}	Setup time before CLK↑	PRE or CLR inactive	10			10			115
t _h	Hold time after CLK↑	Data	0			0			ns
TA	Operating free-air temperature		-55		125	0		70	°C



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electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

DA.	ARAMETER	TEST CO.	NDITIONS	SN5	4ALS10	9A	SN7	4ALS10	9A	UNIT	
PA	ARAMETER	1231 00	NUTTIONS	MIN	TYP [†]	MAX	MIN	TYP†	MAX	UNIT	
VIK		$V_{CC} = 4.5 \text{ V},$	$I_{ } = -18 \text{ mA}$			-1.5			-1.5	V	
Vон		$V_{CC} = 4.5 \text{ V to } 5.5 \text{ V},$	$I_{OH} = -0.4 \text{ mA}$	V _{CC} -2			V _{CC} -2			V	
\/01		V _{CC} = 4.5 V	$I_{OL} = 4 \text{ mA}$		0.25	0.4		0.25	0.4	V	
VOL		VCC = 4.5 V	I _{OL} = 8 mA					0.35	0.5	V	
1.	CLK, J, or K	V00 - 5 5 V	V _I = 7 V			0.1			0.1	mA	
"	PRE or CLR	V _{CC} = 5.5 V,	V = 7 V			0.2			0.2	mA	
1	CLK, J, or K	V 55V	V. 07V			20			20	^	
lін	PRE or CLR	V _{CC} = 5.5 V,	V _I = 2.7 V			40			40	μΑ	
1	CLK, J, or K	V 55V	V- 0.4 V			-0.2			-0.2	mA	
IIL	PRE or CLR	$V_{CC} = 5.5 \text{ V},$	V _I = 0.4 V			-0.4			-0.4	mA	
I _O ‡		$V_{CC} = 5.5 \text{ V},$	V _O = 2.25 V	-20		-112	-30		-112	mA	
Icc		V _{CC} = 5.5 V,	See Note 1		2.4	4		2.4	4	mA	

[†] All typical values are at $V_{CC} = 5 \text{ V}$, $T_A = 25^{\circ}\text{C}$.

switching characteristics (see Figure 1)

PARAMETER	FROM (INPUT)	TO (OUTPUT)	V _C C _l R _l T _A	UNIT			
	, ,	, ,	SN54AL	S109A	SN74AL		
			MIN	MAX	MIN	MAX	
f _{max}			30		34		MHz
t _{PLH}	PRE or CLR	Q or Q	3	17	3	13	ns
^t PHL	PRE OF CLR	Q or Q	5	17	5	15	115
t _{PLH}	CLK	Q or Q	5	21	5	16	ns
^t PHL	OLK	QUIQ	5	20	5	18	115

[§] For conditions shown as MIN or MAX, use the appropriate value specified under recommended operating conditions.

[‡] The output conditions have been chosen to produce a current that closely approximates one half of the true short-circuit output current, I_{OS}. NOTE 1: I_{CC} is measured with J, K, CLK, and PRE grounded, then with J, K, CLK, and CLR grounded.

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absolute maximum ratings over operating free-air temperature range (unless otherwise noted)†

Supply voltage, V _{CC}	7 V
Input voltage, V _I	7 V
Operating free-air temperature range, T _A : SN54AS109A	-55°C to 125°C
SN74AS109A	0°C to 70°C
Storage temperature range	-65°C to 150°C

[†] Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

recommended operating conditions

			SN	54AS10	9A	SN	74AS109)A	UNIT	
			MIN	NOM	MAX	MIN	NOM	MAX	UNII	
VCC	Supply voltage		4.5	5	5.5	4.5	5	5.5	V	
VIH	High-level input voltage		2			2			V	
V _{IL}	Low-level input voltage				0.8			0.8	V	
ІОН	High-level output current				-2			-2	mA	
l _{OL}	Low-level output current				20			20	mA	
fclock*	Clock frequency		0		90	0		105	MHz	
		PRE or CLR low	4			4				
t _W *	Pulse duration	CLK high	4			4			ns	
		CLK low	5.5			5.5				
4 *	Octor than before OUK	Data	5.5			5.5			no	
t _{su} *	Setup time before CLK↑	PRE or CLR inactive	2			2			ns	
th*	Hold time after CLK↑	Data	0			0			ns	
TA	Operating free-air temperature		-55		125	0		70	°C	

^{*} On products compliant to MIL-STD-883, Class B, this parameter is based on characterization data but is not production tested.

electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

DADAMETED		TEST CONDITIONS		SN	SN54AS109A			SN74AS109A		
Ε/	PARAMETER TEST CONDITIONS		MIN	TYP [‡]	MAX	MIN	TYP [‡]	MAX	UNIT	
VIK		V _{CC} = 4.5 V,	I _I = -18 mA			-1.2			-1.2	V
Vон	*	$V_{CC} = 4.5 \text{ V to } 5.5 \text{ V},$	$I_{OH} = -2 \text{ mA}$	V _{CC} -2			V _{CC} -2			V
VOL	1	V _{CC} = 4.5 V,	I _{OL} = 20 mA		0.25	0.5		0.25	0.5	V
lį		V _{CC} = 5.5 V,	V _I = 7 V			0.1			0.1	mA
1	CLK, J, or K	V00 - 5 5 V	V _I = 2.7 V			20			20	
ΙΗ	PRE or CLR	V _{CC} = 5.5 V,	V = 2.7 V			40			40	μΑ
l	CLK, J, or K	V 55V	V _I = 0.4 V			-0.5			-0.5	A
ΙΙL	PRE or CLR	V _{CC} = 5.5 V,	V = 0.4 V			-1.8			-1.8	mA
ΙΟ [§]		V _{CC} = 5.5 V,	V _O = 2.25 V	-30		-112	-30		-112	mA
ICC		V _{CC} = 5.5 V,	See Note 1		11.5	17		11.5	17	mA

[‡] All typical values are at $V_{CC} = 5 \text{ V}$, $T_A = 25^{\circ}\text{C}$.



[§] The output conditions have been chosen to produce a current that closely approximates one half of the true short-circuit output current, I_{OS}. NOTE 1: I_{CC} is measured with J, K, CLK, and PRE grounded, then with J, K, CLK, and CLR grounded.

SN54ALS109A, SN54AS109A, SN74ALS109A, SN74AS109A DUAL J-K POSITIVE-EDGE-TRIGGERED FLIP-FLOPS WITH CLEAR AND PRESET SDAS198B – APRIL 1982 – REVISED AUGUST 1995

switching characteristics (see Figure 1)

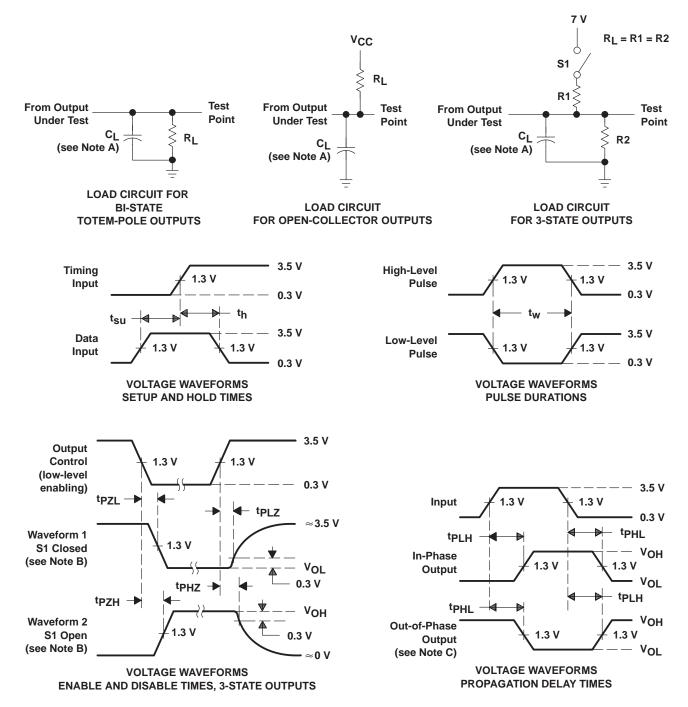
PARAMETER	FROM (INPUT)	TO (OUTPUT)	F	V_{CC} = 4.5 V to 5.5 V, C_L = 50 pF, R_L = 500 Ω , T_A = MIN to MAX [†]				
			SN54A	S109A	SN74AS109A			
			MIN	MAX	MIN	MAX		
f _{max} *			90		105		MHz	
t _{PLH}	PRE or CLR	Q or Q	2	9	2	8	ns	
t _{PHL}	PRE OF CLR	Q or Q	3.5	11.5	3.5	10.5	115	
t _{PLH}	CLK	Q or Q	2.5	10	2.5	9	ns	
^t PHL	OLK	QUIQ	3.5	10.5	3.5	9	115	

^{*} On products compliant to MIL-STD-883, Class B, this parameter is based on characterization data but is not production tested.

[†] For conditions shown as MIN or MAX, use the appropriate value specified under recommended operating conditions.

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PARAMETER MEASUREMENT INFORMATION SERIES 54ALS/74ALS AND 54AS/74AS DEVICES



NOTES: A. C_L includes probe and jig capacitance.

- B. Waveform 1 is for an output with internal conditions such that the output is low except when disabled by the output control. Waveform 2 is for an output with internal conditions such that the output is high except when disabled by the output control.
- C. When measuring propagation delay items of 3-state outputs, switch S1 is open.
- D. All input pulses have the following characteristics: PRR \leq 1 MHz, t_{Γ} = t_{f} = 2 ns, duty cycle = 50%.
- E. The outputs are measured one at a time with one transition per measurement.

Figure 1. Load Circuits and Voltage Waveforms







28-Feb-2005

PACKAGING INFORMATION

Orderable Device	Status ⁽¹⁾	Package Type	Package Drawing	Pins	Package Qty	Eco Plan ⁽²⁾	Lead/Ball Finish	MSL Peak Temp ⁽³⁾
84000012A	ACTIVE	LCCC	FK	20	1	None	Call TI	Level-NC-NC-NC
8400001EA	ACTIVE	CDIP	J	16	1	None	Call TI	Level-NC-NC-NC
8400001FA	OBSOLETE	CFP	W	16		None	Call TI	Call TI
JM38510/37102B2A	ACTIVE	LCCC	FK	20	1	None	Call TI	Level-NC-NC-NC
JM38510/37102BEA	ACTIVE	CDIP	J	16	1	None	Call TI	Level-NC-NC-NC
SN54ALS109AJ	ACTIVE	CDIP	J	16	1	None	Call TI	Level-NC-NC-NC
SN54AS109AJ	ACTIVE	CDIP	J	16	1	None	Call TI	Level-NC-NC-NC
SN74ALS109AD	ACTIVE	SOIC	D	16	40	Pb-Free (RoHS)	CU NIPDAU	Level-2-260C-1 YEAR/ Level-1-235C-UNLIM
SN74ALS109ADR	ACTIVE	SOIC	D	16	2500	Pb-Free (RoHS)	CU NIPDAU	Level-2-260C-1 YEAR/ Level-1-235C-UNLIM
SN74ALS109AN	ACTIVE	PDIP	N	16	25	Pb-Free (RoHS)	CU NIPDAU	Level-NC-NC-NC
SN74ALS109AN3	OBSOLETE	PDIP	N	16		None	Call TI	Call TI
SN74ALS109ANSR	ACTIVE	SO	NS	16	2000	Pb-Free (RoHS)	CU NIPDAU	Level-2-260C-1 YEAR/ Level-1-235C-UNLIM
SN74AS109AD	ACTIVE	SOIC	D	16	40	Pb-Free (RoHS)	CU NIPDAU	Level-2-260C-1 YEAR/ Level-1-235C-UNLIM
SN74AS109ADR	ACTIVE	SOIC	D	16	2500	Pb-Free (RoHS)	CU NIPDAU	Level-2-260C-1 YEAR/ Level-1-235C-UNLIM
SN74AS109AN	ACTIVE	PDIP	N	16	25	Pb-Free (RoHS)	CU NIPDAU	Level-NC-NC-NC
SN74AS109ANSR	ACTIVE	SO	NS	16	2000	Pb-Free (RoHS)	CU NIPDAU	Level-2-260C-1 YEAR/ Level-1-235C-UNLIM
SNJ54ALS109AFK	ACTIVE	LCCC	FK	20	1	None	Call TI	Level-NC-NC-NC
SNJ54ALS109AJ	ACTIVE	CDIP	J	16	1	None	Call TI	Level-NC-NC-NC
SNJ54AS109AFK	ACTIVE	LCCC	FK	20	1	None	Call TI	Level-NC-NC-NC
SNJ54AS109AJ	ACTIVE	CDIP	J	16	1	None	Call TI	Level-NC-NC-NC

⁽¹⁾ The marketing status values are defined as follows:

ACTIVE: Product device recommended for new designs.

LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

PREVIEW: Device has been announced but is not in production. Samples may or may not be available.

OBSOLETE: TI has discontinued the production of the device.

None: Not yet available Lead (Pb-Free).

Pb-Free (RoHS): TI's terms "Lead-Free" or "Pb-Free" mean semiconductor products that are compatible with the current RoHS requirements for all 6 substances, including the requirement that lead not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, TI Pb-Free products are suitable for use in specified lead-free processes.

Green (RoHS & no Sb/Br): TI defines "Green" to mean "Pb-Free" and in addition, uses package materials that do not contain halogens, including bromine (Br) or antimony (Sb) above 0.1% of total product weight.

(3) MSL, Peak Temp. -- The Moisture Sensitivity Level rating according to the JEDECindustry standard classifications, and peak solder temperature.

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⁽²⁾ Eco Plan - May not be currently available - please check http://www.ti.com/productcontent for the latest availability information and additional product content details.



PACKAGE OPTION ADDENDUM

28-Feb-2005

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